



Advanced Materials in 3D Printing

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Message from the Guest Editors

Additive manufacturing (AM), commonly referred as 3D printing, plays an unquestionably important role in the world today. Cited by Forbes, Wohlers Report 2020 states that in 2019, the AM industry, consisting of all AM products and services worldwide, grew 25% to \$12 billion. Besides the importance already achieved by AM at the present time, it is expected that its significance will increase in the future. AM's contributions extend to several relevant fields such as aerospace, automotive, construction, electronics, energy, healthcare, and optics.

The aim of this Special Issue is to provide a scientific platform regarding the development of advanced materials for 3D printing to discuss the present advances and challenges in 3D printing technologies. The Special Issue, entitled Advanced Materials in 3D Printing, is intended to be a broad spectrum forum for the presentation of publications in the form of original research articles or review papers addressing the most recent studies on the synthesis, processing, and characterization of advanced materials for 3D printing.





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Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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